Tender of 3-year HKD HKSAR Institutional Government Bonds to be held on October 23

The following is issued on behalf of the Hong Kong Monetary Authority:

The Hong Kong Monetary Authority (HKMA), as representative of the Hong Kong Special Administrative Region Government (HKSAR Government), announced today (October 21) that a tender of 3-year HKD Institutional Government Bonds (Bonds) under the Infrastructure Bond Programme will be held on Wednesday, October 23, 2024, for settlement on Thursday, October 24, 2024.

A total of HK\$5.5 billion 3-year HKD Bonds will be tendered. The Bonds will mature on October 25, 2027 and will carry interest at the rate of 2.89 per cent per annum payable semi-annually in arrear.

Tender is open only to Primary Dealers appointed under the Infrastructure Bond Programme. Anyone wishing to apply for the Bonds on offer can do so through any of the Primary Dealers on the latest published list, which can be obtained from the Hong Kong Government Bonds website at www.hkgb.gov.hk. Each tender must be for an amount of HK\$50,000 or integral multiples thereof.

Tender results will be published on the HKMA's website, the Hong Kong Government Bonds website, Bloomberg (GBHK <GO>) and Refinitiv (HKGBINDEX). The publication time is expected to be no later than 3pm on the tender day.

HKSAR Institutional Government Bonds tender information

Tender information of 3-year HKD HKSAR Institutional Government Bonds:

Issue Number : 03GB2710001

Stock Code : 4283 (HKGB 2.89 2710)

Tender Date and Wednesday, October 23, 2024

Time 9.30am to 10.30am

Issue and

: Thursday, October 24, 2024 Settlement Date

Amount on Offer : HK\$5.5 billion

: 3 years Maturity

Maturity Date : Monday, October 25, 2027

2.89 per cent p.a. payable semi-annually Interest Rate

in arrear

April 24 and October 24 in each year, commencing on the Issue Date up to and including the Maturity Date, subject to adjustment in accordance with the terms of the Institutional Issuances Information Memorandum of the Infrastructure Bond

Programme and Government Sustainable Bond

Programme (Information Memorandum)

published on the Hong Kong Government Bonds website.

Method of Tender : Competitive tender

Interest Payment

Tender Amount

Expected

Dates

Each competitive tender must be for an amount of HK\$50,000 or integral multiples thereof. Any tender applications for the

Bonds must be submitted through a Primary Dealer on the latest published list.

Please see the Information Memorandum

Other Details : available on the Hong Kong Government
Bonds website or approach Primary Dealers.

commencement date of dealing on the : Friday, October 25, 2024

Stock Exchange of
Hong Kong Limited

Use of Proceeds : in infrastructure projects in accordance with the Infrastructure Bond Framework

published on the Hong Kong Government

institutional part of the Infrastructure

The Bonds will be issued under the

Bonds website.